SiJ478DP

RoHS

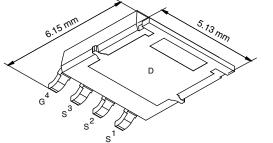
COMPLIANT HALOGEN

FREE

SHAY, www.vishay.com

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω) Max.	I _D (A)	Q _g (Typ.)			
	0.0080 at V _{GS} = 10 V	60 ^a				
80	0.0088 at V _{GS} = 6.0 V	60 ^a	17.1 nC			
	0.0115 at V _{GS} = 4.5 V	54				

PowerPAK[®] SO-8L Single

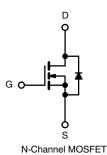


FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_a and UIS Tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Primary Side Switching
- Synchronous Rectification
- DC/AC Inverters
- LED Backlighting



Ordering Information: SiJ478DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	80	v	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		60 ^a		
Continuous Drein Current (T. 150 °C)	T _C = 70 °C		52.7		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	18.6 ^{b, c}		
	T _A = 70 °C		14.9 ^{b, c}	•	
Pulsed Drain Current (t = 100 μs)		I _{DM}	150	— A	
Continuous Source-Drain Diode Current	T _C = 25 °C		60a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	4.5 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	30		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	45	mJ	
	T _C = 25 °C		62.5		
Mauine Davies Disaination	T _C = 70 °C		40	14/	
Maximum Power Dissipation	T _A = 25 °C	P _D	5 ^{b, c}	W	
	T _A = 70 °C		3.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	**	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.5	2.0	0/10

Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 70 °C/W.

Document Number: 62868

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SiJ478DP

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					1	1
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \ \mu A$	80			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			37		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μΑ		- 6.1		mV/°C
Gate-Source Threshold Voltage	V _{GS(th})	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.4		2.6	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
	_	$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 55 °C			10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0064	0.0080	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 6 V, I _D = 15 A		0.0070	0.0088	Ω
		V _{GS} = 4.5 V, I _D = 10 A		0.0087	0.0115	
Forward Transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 20 A		60		S
Dynamic ^b					•	
Input Capacitance	C _{iss}			1855		
Output Capacitance	C _{oss}	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		950		pF
Reverse Transfer Capacitance	C _{rss}			76		1
		$V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		35.5	54	
Total Gate Charge	Qg	$V_{DS} = 40 \text{ V}, V_{GS} = 6 \text{ V}, I_D = 10 \text{ A}$		22	33	
	J J			17.1	26	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 40 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		5.3		
Gate-Drain Charge	Q _{gd}			7.3		
Output Charge	Q _{oss}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$		57	86	
Gate Resistance	Rg	f = 1 MHz	0.5	1.3	2	Ω
Turn-On Delay Time	t _{d(on)}			12	24	
Rise Time	t _r	$V_{DD} = 40 \text{ V}, \text{ R}_{\text{L}} = 4 \Omega$		8	16	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 10 \text{ Å}, V_{\text{GEN}} = 10 \text{ V}, R_g = 1 \Omega$		32	64	
Fall Time	t _f			7	14	
Turn-On Delay Time	t _{d(on)}			14	28	ns
Rise Time	t _r	$V_{DD} = 40 \text{ V}, \text{ R}_{\text{I}} = 4 \Omega$		11	22	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 6.0 \text{ V}, R_g = 1 \Omega$		30	60	1
Fall Time	t _f			8	16	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			60	
Pulse Diode Forward Current (t = $100 \ \mu s$)	I _{SM}				150	A
Body Diode Voltage	V _{SD}	I _S = 5 A		0.76	1.1	V
Body Diode Reverse Recovery Time				38	75	ns
Body Diode Reverse Recovery Charge	Q _{rr}			36	70	nC
Reverse Recovery Fall Time	t _a	I_F = 10 A, dI/dt = 100 A/µs, T _J = 25 °C		19	İ	
Reverse Recovery Rise Time	t _b			19		ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Document Number: 62868

S13-1386-Rev. A, 17-Jun-13 For technical questions, contact: pmostechsupport@vishay.com

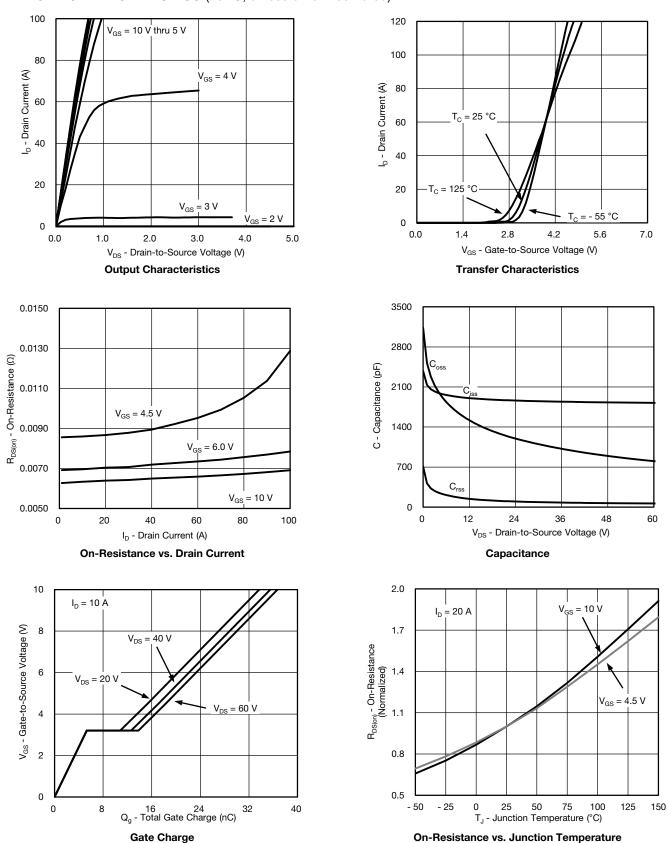
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

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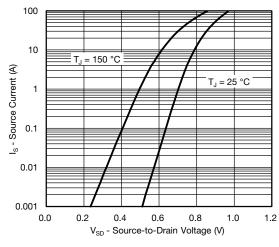
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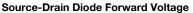
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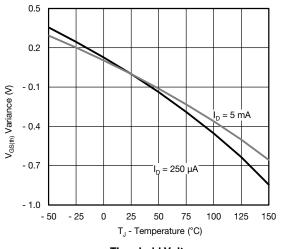
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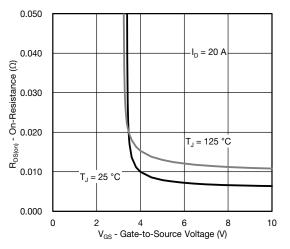
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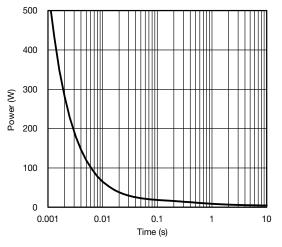




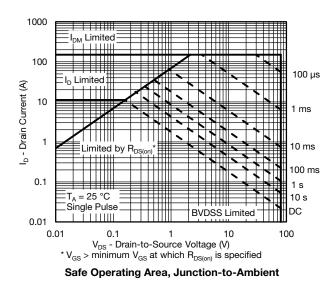




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

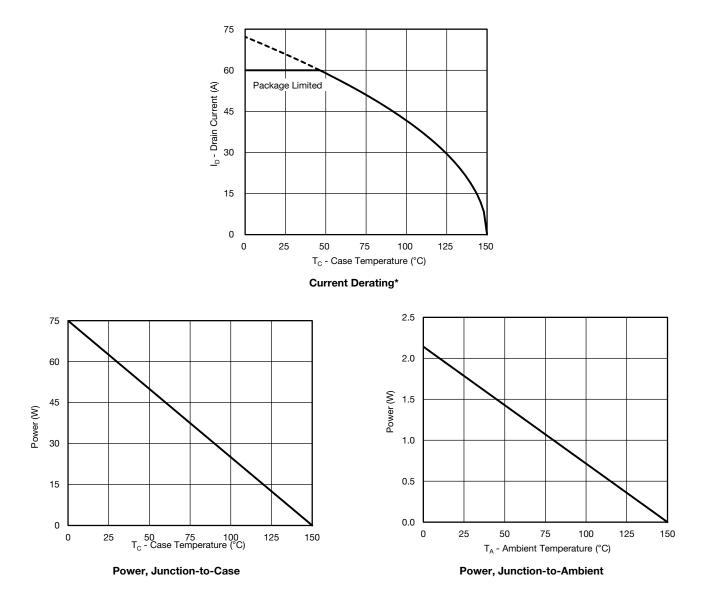


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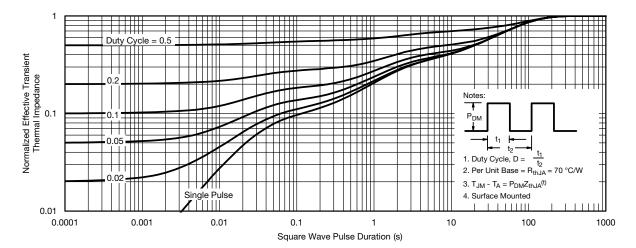


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

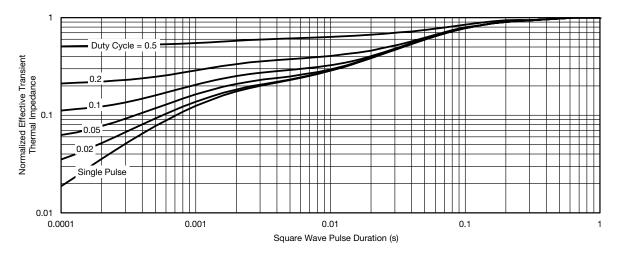
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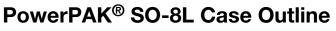
Normalized Thermal Transient Impedance, Junction-to-Ambient

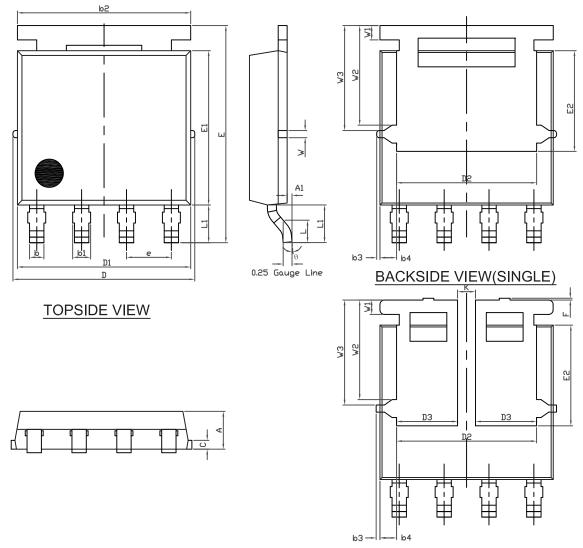


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62868.







BACKSIDE VIEW(DUAL)

Package Information



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DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	·		0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е	1.27 BSC			0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2 (for AI product)	2.75	2.85	2.95	0.108	0.112	0.116	
E2 (for other product)	3.18	3.28	3.38	0.125	0.129	0.133	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К	0.51			0.020			
W	0.23			0.009			
W1	0.41			0.016			
W2	2.82			0.111			
W3	2.96			0.117			
θ	0°	-	10°	0°	-	10°	

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



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